

1.8V, 18 μ A, RRIO

Zero-Drift Operational Amplifiers

Features

- Low offset Voltage: 20 μ V (Max.)
- Zero Drift: 0.05 μ V/ $^{\circ}$ C
- Low Quiescent Current: 18 μ A
- Gain Bandwidth Product: 350kHz
- Operates on 1.8V ~ 5.5V Supplies
- Slew Rate: 0.2V/ μ s
- Rail-to-Rail Input and Output (RRIO)
- Unity Gain Stable
- No Phase Reversal
- Extended Temperature Ranges
From -40 $^{\circ}$ C to +125 $^{\circ}$ C
- Small Packaging
COS1333 available in SOT23-5/SOP-8
COS2333 available in SOP-8/MSOP-8
COS4333 available in SOP14/TSSOP14

Applications

- Sensor Conditioning
- Temperature Measurements
- Transducers
- Test Equipment
- Medical Instrumentation
- Battery Powered Instruments
- A/D converters

General Description

The COS1333 (single), COS2333 (dual) and COS4333 (quad) are micro power, zero-drift operational amplifiers operated on 1.8 to 5.5 supplies. COSx333 family use chopper stabilized technique to provide very low offset voltage (less than 30 μ V maximum) and near zero drift over temperature. Low quiescent supply current of 18 μ A per amplifier and very low input bias current make the devices an ideal choice for low offset, low power consumption and high impedance applications.

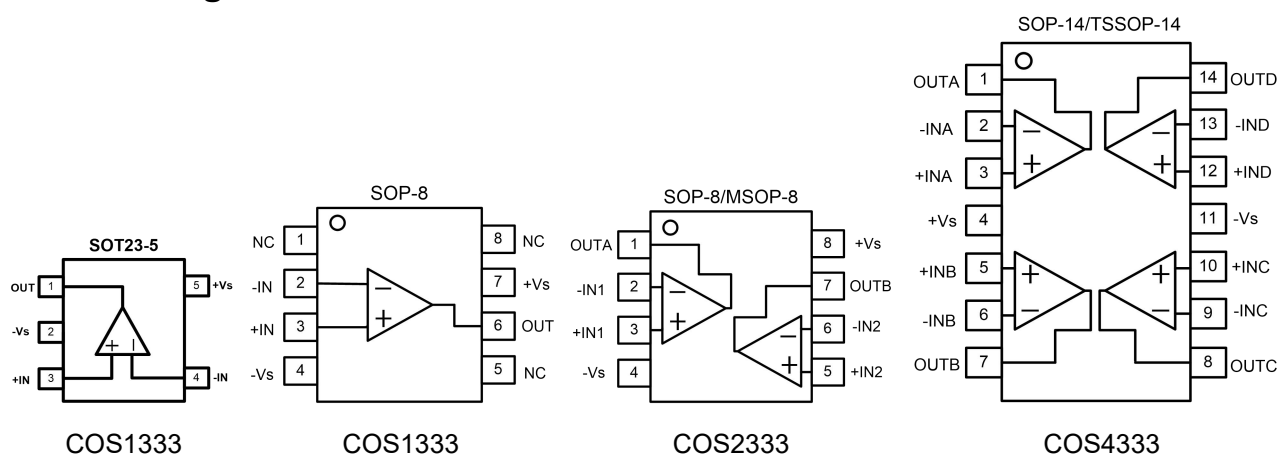
Despite their low quiescent current, the COSx333 family provides excellent overall performance and versatility. They have both rail-to-rail input and output range. The output voltage swing extends to within 5mV of each rail, providing the maximum output dynamic range with excellent overdrive recovery. COSx333 family is unity gain stable and has a gain bandwidth product of 350kHz (typical).

Rev1.0

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1. Pin Configuration and Functions



Pin Functions

Name	Description	Note
+Vs	Positive power supply	A bypass capacitor of 0.1 μ F as close to the part as possible should be placed between power supply pins or between supply pins and ground.
-Vs	Negative power supply or ground	If it is not connected to ground, bypass it with a capacitor of 0.1 μ F as close to the part as possible.
-IN	Negative input	Inverting input of the amplifier. Voltage range of this pin can go from -Vs -0.3V to +Vs + 0.3V.
+IN	Positive input	Non-inverting input of the amplifier. This pin has the same voltage range as -IN.
OUT	Output	The output voltage range extends to within millivolts of each supply rail.
NC	No connection	

2. Package and Ordering Information

Model	Channel	Order Number	Package	Package Option	Marking Information
COS1333	1	COS1333TR	SOT23-5	Tape and Reel, 3000	COS1333
		COS1333SR	SOP-8	Tape and Reel, 3000	COS1333
COS2333	2	COS2333SR	SOP-8	Tape and Reel, 3000	COS2333
		COS2333MR	MSOP-8	Tape and Reel, 3000	COS2333
COS4333	4	COS4333SR	SOP-14	Tape and Reel, 2500	COS4333
		COS4333TR	TSSOP-14	Tape and Reel, 3000	COS4333

3. Product Specification

3.1 Absolute Maximum Ratings ⁽¹⁾

Parameter	Rating	Units
Power Supply: +Vs to -Vs	7.5	V
Input Voltage	-Vs -0.5V to +Vs + 0.5V	V
Input Current ⁽²⁾	10	mA
Storage Temperature Range	-65 to 150	°C
Junction Temperature	150	°C
Operating Temperature Range	-40 to 125	°C
ESD Susceptibility, HBM	2000	V

(1) Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

(2) Input terminals are diode-clamped to the power-supply rails. Input signals that can swing more than 0.5V beyond the supply rails should be current-limited to 10mA or less.

3.2 Thermal Data

Parameter	Rating	Unit
Package Thermal Resistance	190 (SOT23-5) 206 (MSOP8) 155 (SOP8) 105 (TSSOP14) 82 (SOP14)	°C/W

3.3 Recommended Operating Conditions

Parameter	Rating	Unit
DC Supply Voltage	1.8V ~ 5.5V	V
Input common-mode voltage range	-Vs ~ +Vs	V
Operating ambient temperature	-40 to +85	°C

3.4 Electrical Characteristics

(+V_S=+5V, -V_S=0, V_{CM}=V_S/2, T_A=+25°C, R_L=10kΩ to V_S/2, unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Input Characteristics						
Input Offset Voltage	V _{OS}	COS1333A		2	20	μV
		COS1333B			50	
		COS1333C			100	
		COS2333A		5	50	
		COS2333B			100	
		COS2333C			150	
Input Offset Voltage Drift	ΔV _{OS} /ΔT	-40 to 125°C		0.01	0.05	μV/°C
Input Bias Current	I _B			±3		pA
Input Offset Current	I _{OS}			±3		pA
Common-Mode Voltage Range	V _{CM}	V _S = 5.5V	-0.1		5.6	V
Common-Mode Rejection Ratio	CMRR	V _{CM} = 0.1V to 4.9V		120		dB
Open-Loop Voltage Gain	AOL	V _O =0.2V to 4.8V		145		dB
Output Characteristics						
Output Voltage Swing from Rail		R _L =100kΩ		5		mV
		R _L =10kΩ		15		mV
Short-Circuit Current	I _{SR}	Sourcing		7		mA
	I _{SK}	Sinking		-7		mA
Power Supply						
Operating Voltage Range			1.8		5.5	V
Power Supply Rejection Ratio	PSRR	V _S = 1.8V to 5.5V	80	100		dB
Quiescent Current / Amplifier	I _Q	V _S = 1.8V		18		μA
Dynamic Performance						
Gain Bandwidth Product	GBWP	G=+1		350		kHz

Slew Rate	SR	G = +1 , 2V Output Step		0.2		V/ μ s
Noise Performance						
Voltage Noise Density	e_n	f=1kHz		70		nV/ $\sqrt{\text{Hz}}$

4.0 Application Notes

Driving Capacitive Loads

Driving large capacitive loads can cause stability problems for voltage feedback op amps. As the load capacitance increases, the feedback loop's phase margin decreases, and the closed loop bandwidth is reduced. This produces gain peaking in the frequency response, with overshoot and ringing in the step response. A unity gain buffer ($G = +1$) is the most sensitive to capacitive loads, but all gains show the same general behavior.

When driving large capacitive loads with these op amps (e.g., > 100 pF when $G = +1$), a small series resistor at the output (R_{ISO} in Figure 1) improves the feedback loop's phase margin (stability) by making the output load resistive at higher frequencies. It does not, however, improve the bandwidth.

To select R_{ISO} , check the frequency response peaking (or step response overshoot) on the bench. If the response is reasonable, you do not need R_{ISO} . Otherwise, start R_{ISO} at 1 k Ω and modify its value until the response is reasonable.

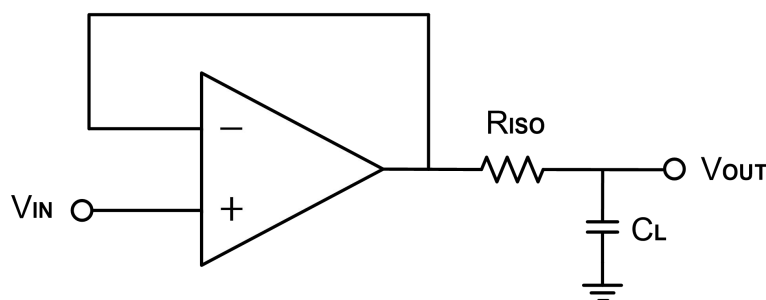


Figure 1. Indirectly Driving Heavy Capacitive Load

An improvement circuit is shown in Figure 2. It provides DC accuracy as well as AC stability. R_F provides the DC accuracy by connecting the inverting signal with the output, C_F and R_{ISO} serve to counteract the loss of phase margin by feeding the high frequency component of the output signal back to the amplifier's inverting input, thereby preserving phase margin in the overall feedback loop.

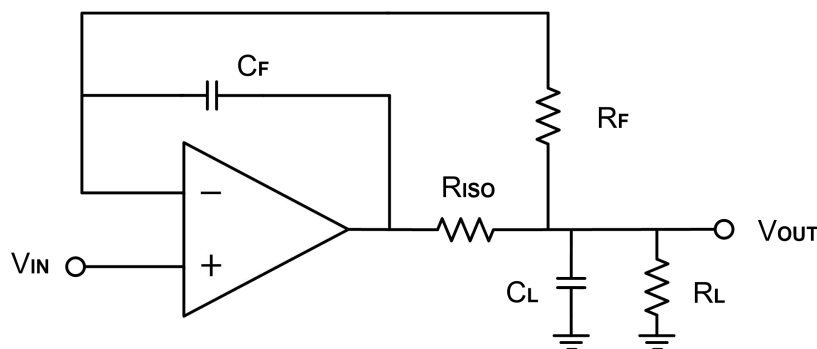


Figure 2. Indirectly Driving Heavy Capacitive Load with DC Accuracy

For noninverting configuration, there are two others ways to increase the phase margin: (a) by increasing the amplifier's gain or (b) by placing a capacitor in parallel with the feedback resistor to counteract the parasitic capacitance associated with inverting node, as shown in Figure 3.

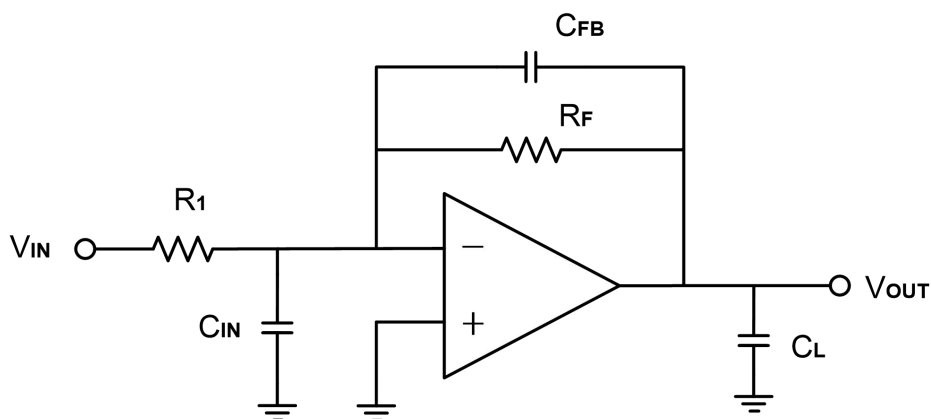


Figure 3. Adding a Feedback Capacitor in the Noninverting Configuration

Power-Supply Bypassing and Layout

The COSx333 operates from a single +1.8V to +5.5V supply or dual $\pm 0.9V$ to $\pm 2.75V$ supplies. For single-supply operation, bypass the power supply +Vs with a 0.1 μF ceramic capacitor which should be placed close to the +Vs pin. For dual-supply operation, both the +Vs and the -Vs supplies should be bypassed to ground with separate 0.1 μF ceramic capacitors. 2.2 μF tantalum capacitor can be added for better performance.

The length of the current path is directly proportional to the magnitude of parasitic inductances and thus the high frequency impedance of the path. High speed currents in an inductive ground return create an unwanted voltage noise. Broad ground plane areas will reduce the parasitic inductance. Thus a ground plane layer is important for high speed circuit design.

Typical Application Circuits

Differential Amplifier

The circuit shown in Figure 4 performs the differential function. If the resistors ratios are equal ($R_4 / R_3 = R_2 / R_1$), then $V_{OUT} = (V_{IP} - V_{IN}) \times R_2 / R_1 + V_{REF}$.

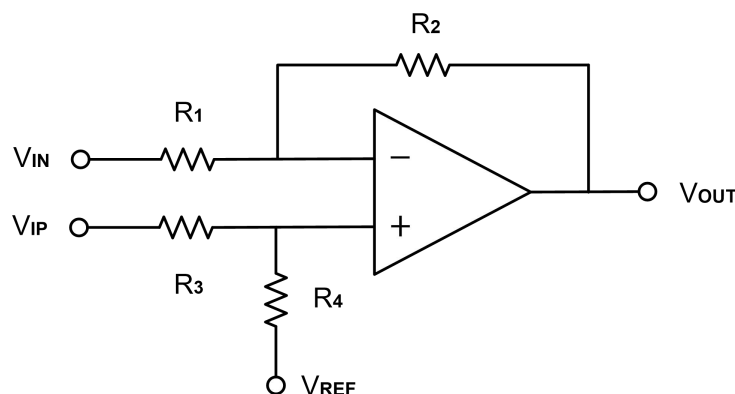


Figure 4. Differential Amplifier

Low Pass Active Filter

When receiving low-level signals, limiting the bandwidth of the incoming signals into the system is often required. The simplest way to establish this limited bandwidth is to place an RC filter at the noninverting terminal of the amplifier. If even more attenuation is needed, a multiple pole filter is required. The Sallen-Key filter can be used for this task, as Figure 5. For best results, the amplifier should have a bandwidth that is 8 to 10 times the filter frequency bandwidth. Failure to follow this guideline can result in reduction of phase margin. The large values of feedback resistors can couple with parasitic capacitance and cause undesired effects such as ringing or oscillation in high-speed amplifiers. Keep resistors value as low as possible and consistent with output loading consideration.

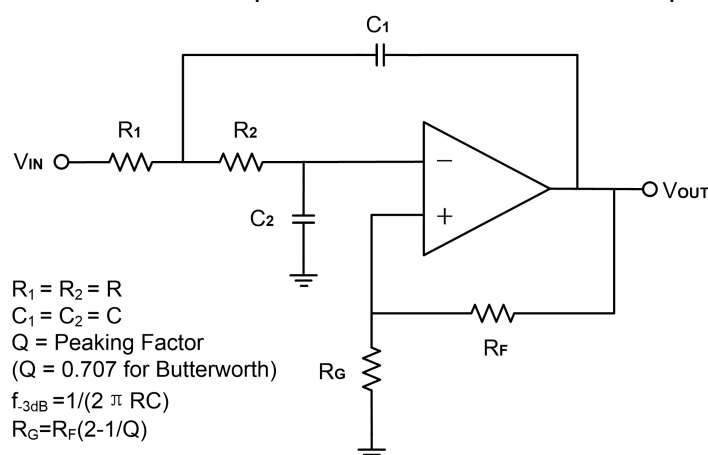
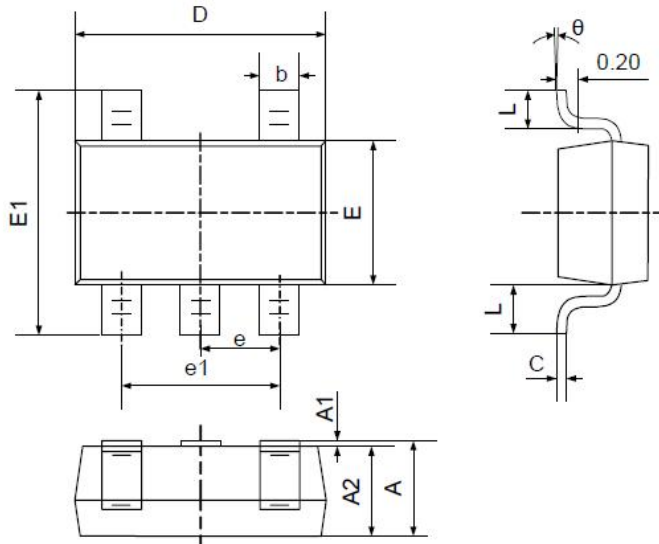


Figure 5. Two-Pole Low-Pass Sallen-Key Active Filter

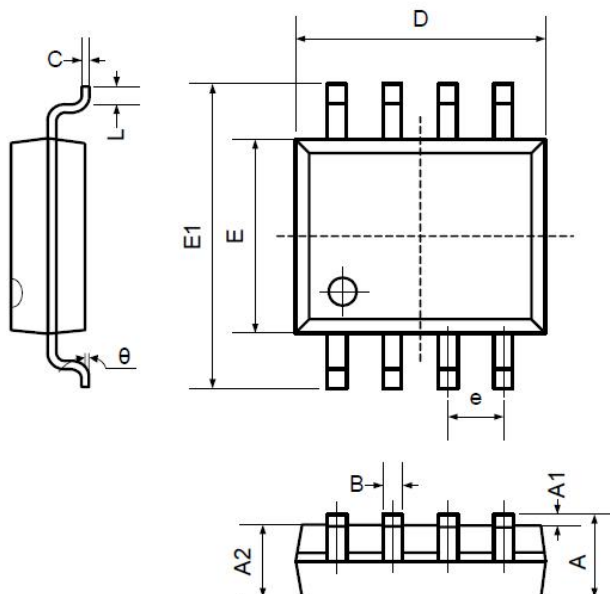
5. Package Information

5.1 SOT23-5 (Package Outline Dimensions)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.400	0.012	0.016
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950TYP		0.037TYP	
e1	1.800	2.000	0.071	0.079
L	0.700REF		0.028REF	
L1	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°

5.2 SOP8 (Package Outline Dimensions)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
B	0.330	0.510	0.013	0.020
C	0.190	0.250	0.007	0.010
D	4.780	5.000	0.188	0.197
E	3.800	4.000	0.150	0.157
E1	5.800	6.300	0.228	0.248
e	1.270TYP		0.050TYP	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

Technical drawing of a rectangular component with dimensions and labels:

- Top View:** Shows a rectangular body with a central circular hole. Dimensions include E (height), $E1$ (total height including top and bottom flanges), b (width of top flange), e (width of bottom flange), and A (width of the body).
- Side View:** Shows the profile of the component, including the top flange, the main body, and the bottom flange. Dimensions include C (width of the top flange), θ (angle of the top flange), $A2$ (width of the top flange), and A (width of the body).
- Bottom View:** Shows the bottom flange with dimensions D (width) and $A1$ (height).

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.800	1.200	0.031	0.047
A1	0.000	0.200	0.000	0.008
A2	0.760	0.970	0.030	0.038
b	0.30 TYP		0.012 TYP	
c	0.15 TYP		0.006 TYP	
D	2.900	3.100	0.114	0.122
e	0.65 TYP		0.026 TYP	
E	2.900	3.100	0.114	0.122
E1	4.700	5.100	0.185	0.201
L	0.410	0.650	0.016	0.026
θ	0°	6°	0°	6°

Technical drawing of a 12-pin D-subminiature connector, showing three views: top view, side view, and cross-section B-B.

Top View:

- Overall width: D
- Overall height: E
- Pin pitch (center-to-center): e
- Pin width: b
- Pin diameter: $\phi 0.25 (M)$
- Index hole diameter: $\phi 0.8 \pm 0.1$
- Deposition thickness: $DEP0.2 \pm 0.1$
- Internal hole diameter: $\phi 2.0 \pm 0.1$ BTM E-MARK
- Internal hole deposition thickness: $DEP0.1 \pm 0.05$

Side View:

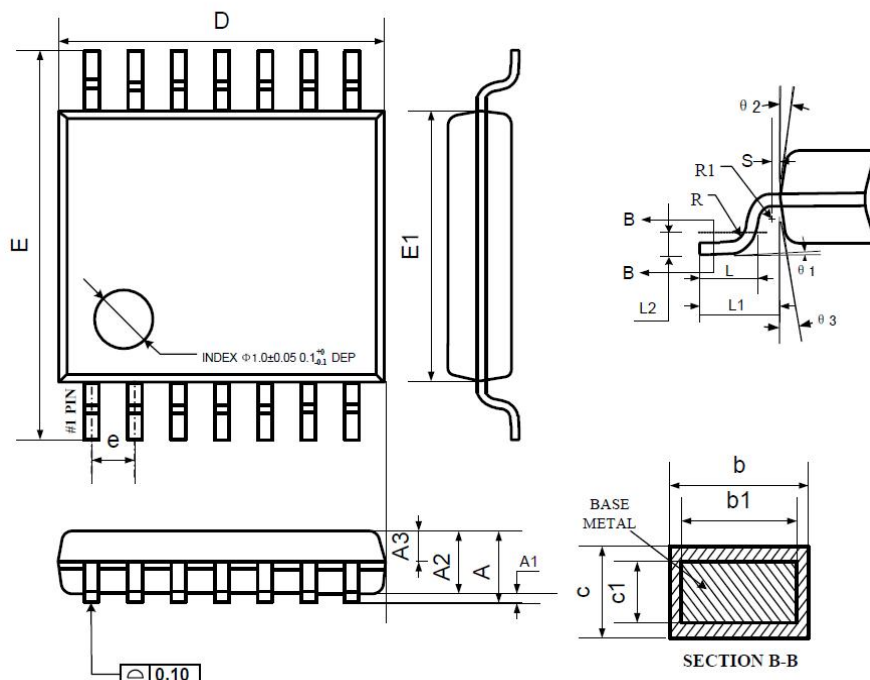
- Overall height: A
- Pin height: $A2$
- Pin diameter: $\phi 3$
- Pin width: $\phi 4$
- Pin thickness: $A1$
- Pin diameter: $\phi 3$
- Pin thickness: $A3$
- Pin diameter: $\phi 0.10$

Cross-section B-B:

- Overall width: b
- Pin width: $b1$
- Overall height: c
- Pin height: $c1$
- Labels: BASE METAL, WITH PLATING

Symbol	Dimensions In Millimeters		
	MIN	NOM	MAX
A	1.35	1.60	1.75
A1	0.10	0.15	0.25
A2	1.25	1.45	1.65
A3	0.55	0.65	0.75
b	0.36		0.49
b1	0.35	0.40	0.45
c	0.16		0.25
c1	0.15	0.20	0.25
D	8.53	8.63	8.73
E	5.80	6.00	6.20
E1	3.80	3.90	4.00
e		1.27 BSC	
L	0.45	0.60	0.80
L1		1.04 REF	
L2		0.25 BSC	
R	0.07		
R1	0.07		
h	0.30	0.40	0.50
θ	0°		8°
θ1	6°	8°	10°
θ2	6°	8°	10°
θ3	5°	7°	9°
θ4	5°	7°	9°

5.5 TSSOP14 (Package Outline Dimensions)



Symbol	Dimensions In Millimeters		
	MIN	NOM	MAX
A	—	—	1.20
A1	0.05	—	0.15
A2	0.90	1.00	1.05
A3	0.34	0.44	0.54
b	0.20	—	0.28
b1	0.20	0.22	0.24
c	0.10	—	0.19
c1	0.10	0.13	0.15
D	4.86	4.96	5.06
E	6.20	6.40	6.60
E1	4.30	4.40	4.50
e	0.65 BSC		
L	0.45	0.60	0.75
L1	1.00 REF		
L2	0.25 BSC		
R	0.09	—	—
R1	0.09	—	—
S	0.20	—	—
$\theta 1$	0°	—	8°
$\theta 2$	10°	12°	14°
$\theta 3$	10°	12°	14°

6. Related Parts

Part Number	Description
COS6041/2/4	24kHz, 0.5 μ A, RRIO Op Amps, 1.8 to 5.5V Supply
COS1347/2347/4347	350kHz, 15 μ A, RRIO Op Amps, 1.8 to 5.5V Supply
COS6001/2/4	1.5MHz, 50 μ A, RRIO Op Amps, 1.8 to 5.5V Supply
COS1314/2314/4314	3MHz, 150 μ A, RRIO Op Amps, 1.8 to 5.5V Supply
COS821/2/4	5MHz, 300 μ A, RRIO Op Amps, 1.8 to 5.5V Supply
COS1374/2374/4374	7MHz, 500 μ A, RRIO Op Amps, 1.8 to 5.5V Supply
COS721/2/4	10MHz, 650 μ A, RRIO Op Amps, 2.1 to 5.5V Supply
COS8551/2/4	1.5MHz, 55 μ A, RRIO Op Amps, 1.8 to 5.5V Supply, Zero Drift, Vos<10 μ V